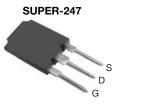
SiHS90N65E

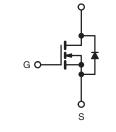
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} (Ω) typ. at 25 °C	$V_{GS} = 10 V$	0.025			
Q _g (nC) max.	591				
Q _{gs} (nC)	84				
Q _{gd} (nC)	160				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Super-247
Lead (Pb)-free	SiHS90N65E-E3

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	650	V			
Gate-Source Voltage			V _{GS}	± 30	v		
Continuous Drain Current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	87			
	VGS at 10 V	T _C = 100 °C		55	А		
Pulsed Drain Current ^a			I _{DM}	323			
Linear Derating Factor				5	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	1930	mJ		
Maximum Power Dissipation			P _D	625	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C			
Drain-Source Voltage Slope	T _J = 125 °C		d\//dt	41	V/ns		
Reverse Diode dV/dt ^d		dV/dt	4.1	v/ns			
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 11.7 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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(e)

ROHS COMPLIANT



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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 40						
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.2				°C/W		
			·					
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDITIO	NS	MIN.	TYP.	MAX.	UNI
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	V _{GS} = 0 V, I _D = 250 μA			-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$		Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.83	-	V/°C
Gate Threshold Voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 25		2.0	-	4.0	V
			$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}				-	-	± 1	μA
Zava Cata Valtaga Drain Current	1-	V _{DS} =	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 \	$V_{\rm GS} = 0 \rm V,^{-1}$	T _J = 125 °C	-	-	25	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D =	= 45 A	-	0.025	0.029	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 30 V, I _D = 45 A		-	32	-	S	
Dynamic						-		
Input Capacitance	C _{iss}	$V_{GS} = 0 V, \\ V_{DS} = 100 V, \\ f = 300 \text{ kHz}$		-	11 826	-	-	
Output Capacitance	C _{oss}			-	528	-		
Reverse Transfer Capacitance	C _{rss}			-	9	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 0 V to 520 V		-	384	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	1502	-]	
Total Gate Charge	Qg	V _{GS} = 10 V I _D = 45 A, V _{DS} = 520 V		-	394	591	nC	
Gate-Source Charge	Q _{gs}			-	84	-		
Gate-Drain Charge	Q _{gd}				-	160	-	1
Turn-On Delay Time	t _{d(on)}				-	85	128	
Rise Time	t _r	V_{DD} = 520 V, I_D = 45 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	152	228	- ns	
Turn-Off Delay Time	t _{d(off)}			-	323	485		
Fall Time	t _f			-	267	401		
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.6	1.2	2.4	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	87		
Pulsed Diode Forward Current	I _{SM}			-	-	323	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 45 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 45 \text{ A},$ $dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	971	1942	ns	
Reverse Recovery Charge	Q _{rr}			-	26	52	μC	
Reverse Recovery Current	I _{RRM}			-	42	_	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .





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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

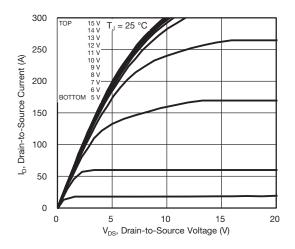
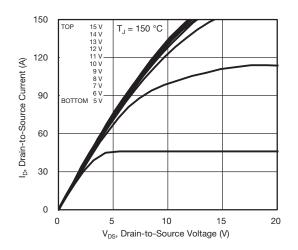
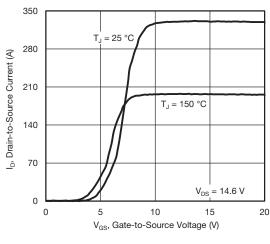


Fig. 1 - Typical Output Characteristics









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3.0 45 Drain-to-Source On-Resistance 2.5 2.0 (Nomalized) 1.0 10\ R_{DS(on)}, L GS 0.5 0 -40 -60 -20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

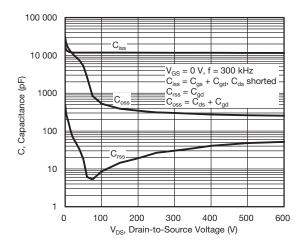


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

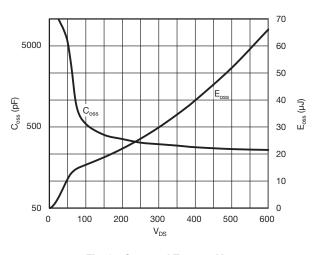


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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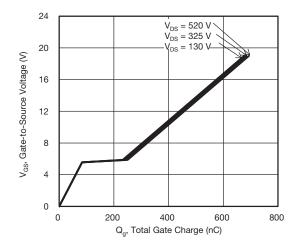


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

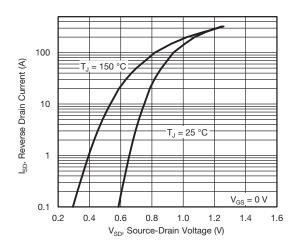


Fig. 8 - Typical Source-Drain Diode Forward Voltage

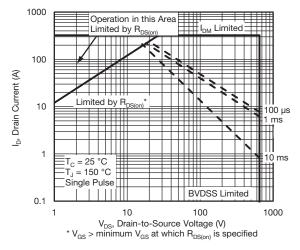


Fig. 9 - Maximum Safe Operating Area

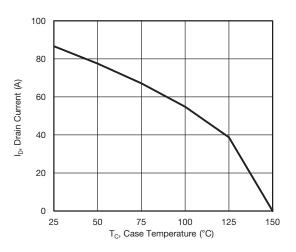


Fig. 10 - Maximum Drain Current vs. Case Temperature

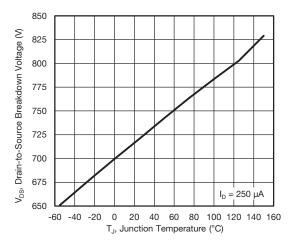


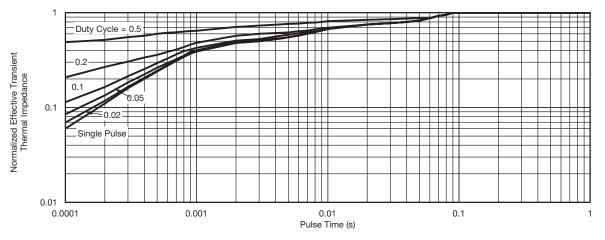
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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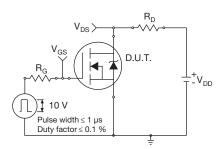


Fig. 13 - Switching Time Test Circuit

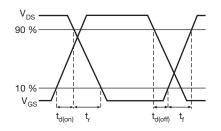


Fig. 14 - Switching Time Waveforms

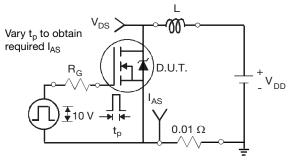


Fig. 15 - Unclamped Inductive Test Circuit

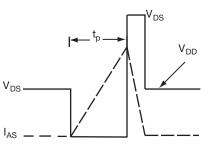


Fig. 16 - Unclamped Inductive Waveforms

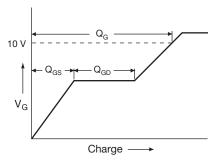


Fig. 17 - Basic Gate Charge Waveform

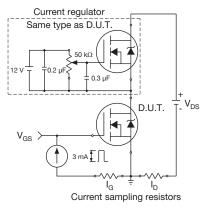


Fig. 18 - Gate Charge Test Circuit

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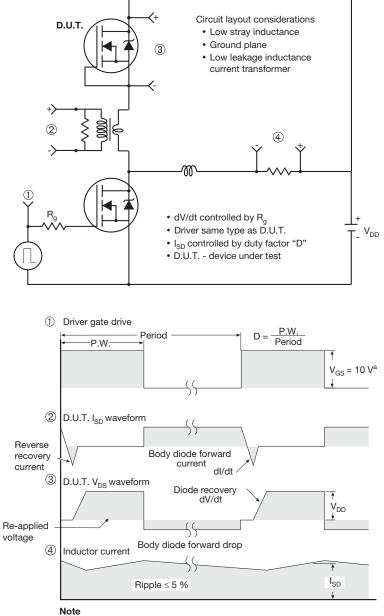
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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